

Silicon Carbide (SiC) MOSFET - EliteSiC, 65 mohm, 1200 V, M3S, TO-247-3L NTHL070N120M3S

Features

- Typ. $R_{DS(on)} = 65 \text{ m}\Omega @ V_{GS} = 18 \text{ V}$
- Ultra Low Gate Charge $(Q_{G(tot)} = 57 \text{ nC})$
- High Speed Switching with Low Capacitance ($C_{oss} = 57 \text{ pF}$)
- 100% Avalanche Tested
- This Device is Halide Free and RoHS Compliant with exemption 7a, Pb–Free 2LI (on second level interconnection)

Typical Applications

- Solar Inverters
- Electric Vehicle Charging Stations
- UPS (Uninterruptible Power Supplies)
- Energy Storage Systems
- SMPS (Switch Mode Power Supplies)

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

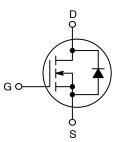
Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V_{DSS}	1200	V
Gate-to-Source Voltage			V_{GS}	-10/+22	V
Recommended Operation Values of Gate-to-Source Voltage		V_{GSop}	-3/+18	>	
Continuous Drain Current (Notes 1, 3)	Steady State	T _C =25°C	I _D	34	Α
Power Dissipation (Note 1)			P _D	160	W
Continuous Drain Current (Notes 1, 3)	Steady State	T _C =100°C	I _D	24	Α
Power Dissipation (Note 1)			P _D	80	W
Pulsed Drain Current (Note 2)	T _C = 25°C		I _{DM}	98	Α
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +175	°C
Source Current (Body Diode) T _C = 25°C, V _{GS} = -3 V			I _S	31	Α
Single Pulse Drain-to-Source Avalanche Energy (Note 4)			E _{AS}	91	mJ
Maximum Lead Temperature for Soldering (1/25" from case for 10 s)			TL	270	°C

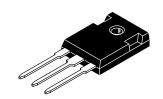
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Repetitive rating, limited by max junction temperature.
- 3. The maximum current rating is based on typical R_{DS(on)} performance.
- 4. EAS of 91 mJ is based on starting $T_J = 25^{\circ}C$; L = 1 mH, $I_{AS} = 13.5$ A, $V_{DD} = 100$ V, $V_{GS} = 18$ V.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
1200 V	87 mΩ @ 18 V	34 A

N-CHANNEL MOSFET





TO-247-3L CASE 340CX

MARKING DIAGRAM



HL070N120M3S = Specific Device Code

A = Assembly Location

Y = Year

WW = Work Week
ZZ = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping		
NTHL070N120M3S	TO-247-3L	30 Units / Tube		

Table 1. THERMAL CHARACTERISTICS

Parameter		Max	Unit
Junction-to-Case - Steady State (Note 1)		0.94	°C/W
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	40	

Table 2. ELECTRICAL CHARACTERISTICS (T. J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
OFF-STATE CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	1200	-	-	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	I _D = 1 mA, referenced to 25°C (Note 6)	-	0.3	-	V/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 1200 V	-	-	100	μΑ
Gate-to-Source Leakage Current	I _{GSS}	$V_{GS} = +22/-10 \text{ V}, V_{DS} = 0 \text{ V}$	-	_	±1	μΑ
ON-STATE CHARACTERISTICS (Note 2)						
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = 7 \text{ mA}$	2.04	2.9	4.4	V
Recommended Gate Voltage	V_{GOP}		-3	_	+18	V
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 18 V, I _D = 15 A, T _J = 25°C	-	65	87	mΩ
		V _{GS} = 18 V, I _D = 15 A, T _J = 175°C (Note 6)	-	136	-	
Forward Transconductance	9 _{FS}	V _{DS} = 10 V, I _D = 15 A (Note 6)	-	12	-	S
CHARGES, CAPACITANCES & GATE RE	SISTANCE					
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 800 V	-	1230	-	pF
Output Capacitance	C _{OSS}		-	57	-	1
Reverse Transfer Capacitance	C _{RSS}		_	5	-	
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = -3/18 \text{ V}, V_{DS} = 800 \text{ V},$ $I_{D} = 15 \text{ A}$	-	57	-	nC
Threshold Gate Charge	Q _{G(TH)}	I _D = 15 A	-	3.2	-	
Gate-to-Source Charge	Q _{GS}		-	9.6	-	
Gate-to-Drain Charge	Q_{GD}		_	17	-	
Gate-Resistance	R_{G}	f = 1 MHz	-	4.3	-	Ω
SWITCHING CHARACTERISTICS			•	•		•
Turn-On Delay Time	t _{d(ON)}	$V_{GS} = -3/18 \text{ V}, V_{DS} = 800 \text{ V},$	-	10	-	ns
Rise Time	t _r	$I_D = 15 \text{ A}, R_G = 4.7 \Omega$ Inductive load (Notes 5, 6)	_	24	-	
Turn-Off Delay Time	t _{d(OFF)}		-	29	-	
Fall Time	t _f		-	9.6	-	
Turn-On Switching Loss	E _{ON}		_	254	-	μJ
Turn-Off Switching Loss	E _{OFF}		-	46	-	
Total Switching Loss	E _{tot}		-	300	-	1
SOURCE-DRAIN DIODE CHARACTERIS			-	-		-
Continuous Source-Drain Diode Forward Current	I _{SD}	$V_{GS} = -3 \text{ V, } T_{C} = 25^{\circ}\text{C (Note 6)}$	-	-	31	А
Pulsed Source–Drain Diode Forward Current (Note 2)	I _{SDM}		_	_	98	
Forward Diode Voltage	V_{SD}	V _{GS} = -3 V, I _{SD} = 15 A, T _J = 25°C	-	4.7	_	V

 Table 2. ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified) (continued)

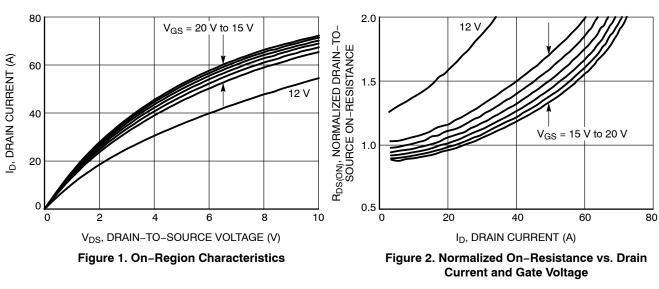
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
SOURCE-DRAIN DIODE CHARACTERISTICS							
Reverse Recovery Time	t _{RR}	$V_{GS} = -3/18 \text{ V}, I_{SD} = 15 \text{ A},$ $dI_S/dt = 1000 \text{ A}/\mu\text{s}, V_{DS} = 800 \text{ V}$	-	14	-	ns	
Reverse Recovery Charge	Q _{RR}	dl _S /dt = 1000 A/μs, V _{DS} = 800 V (Note 6)	-	57	-	nC	
Reverse Recovery Energy	E _{REC}	1	-	3.1	_	μJ	
Peak Reverse Recovery Current	I _{RRM}	1	-	8.2	_	Α	
Charge Time	T _A		-	7.7	_	ns	
Discharge Time	T _B	1	_	6.2	-	ns	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

5. E_{ON}/E_{OFF} result is with body diode.

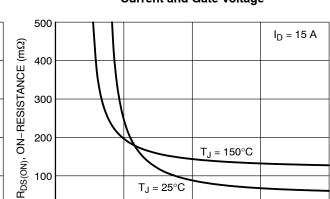
6. Defined by design, not subject to production test.

TYPICAL CHARACTERISTICS



0

4



 $T_J = 25^{\circ}C$

8

2.5 I_D = 15 A R_{DS(ON)}, NORMALIZED DRAIN-TO-SOURCE ON-RESISTANCE V_{GS} = 18 V 2.0 1.5 1.0 0.5 -50 25 50 75 100 125 150 175 200 -75 -25 0 T_J, JUNCTION TEMPERATURE (°C)

Figure 3. On-Resistance Variation with **Temperature**

Figure 4. On-Resistance vs. Gate-to-Source Voltage

12

V_{GS}, GATE-TO-SOURCE VOLTAGE (V)

16

20

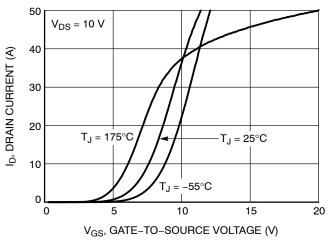


Figure 5. Transfer Characteristics

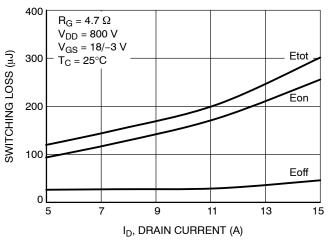


Figure 6. Switching Loss vs. Drain Current

TYPICAL CHARACTERISTICS

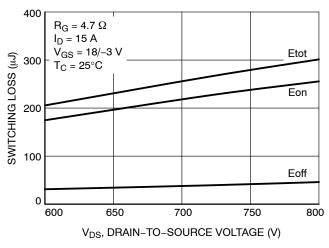


Figure 7. Switching Loss vs. Drain-to-Source Voltage

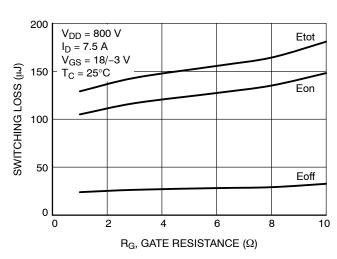


Figure 8. Switching Loss vs. Gate Resistance

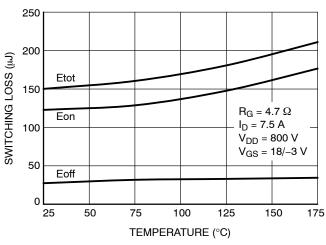


Figure 9. Switching Loss vs. Temperature

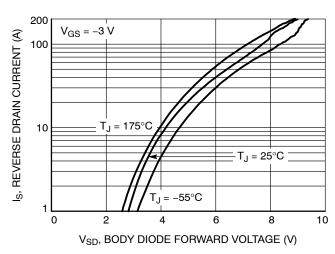


Figure 10. Reverse Drain Current vs. Body Diode Forward Voltage

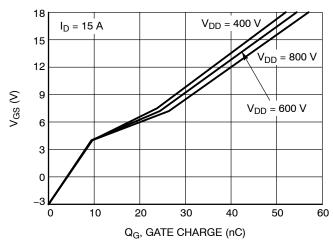


Figure 11. Gate-to-Source Voltage vs. Total Charge

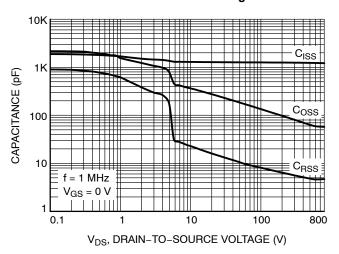


Figure 12. Capacitance vs. Drain-to-Source Voltage

TYPICAL CHARACTERISTICS

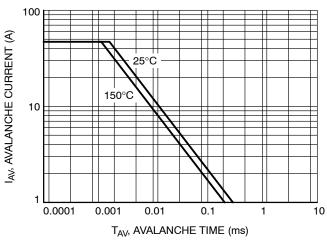


Figure 13. Unclamped Inductive Switching Capability

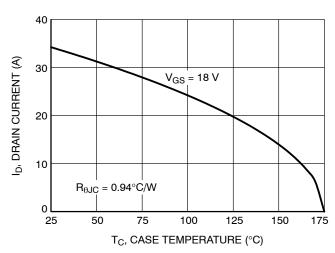


Figure 14. Maximum Continuous Drain Current vs. Case Temperature

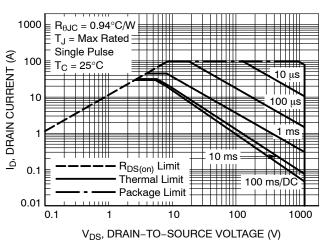


Figure 15. Safe Operating Area

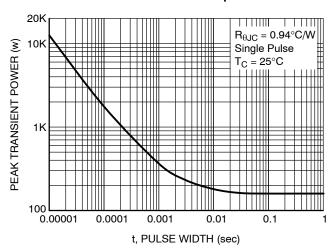


Figure 16. Single Pulse Maximum Power Dissipation

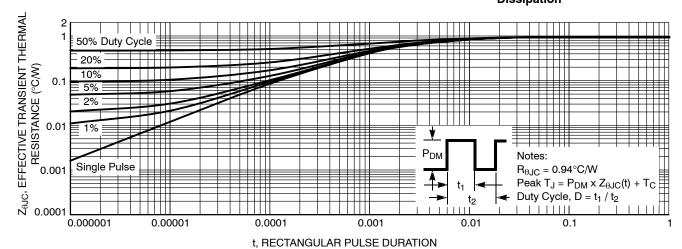
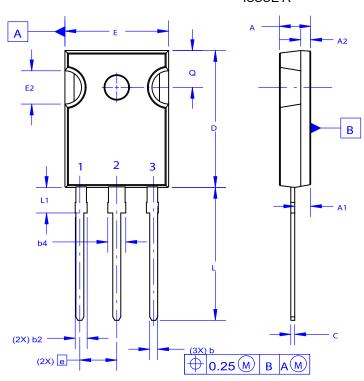


Figure 17. Junction-to-Case Transient Thermal Response

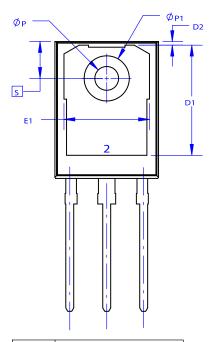
PACKAGE DIMENSIONS

TO-247-3LD CASE 340CX ISSUE A



NOTES: UNLESS OTHERWISE SPECIFIED.

- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.



DIM	MIL	LIMETER	S
DIM	MIN	NOM	MAX
Α	4.58	4.70	4.82
A 1	2.20	2.40	2.60
A2	1.40	1.50	1.60
D	20.32	20.57	20.82
Е	15.37	15.62	15.87
E2	4.96	5.08	5.20
е	?	5.56	~
L	19.75	20.00	20.25
L1	3.69	3.81	3.93
ØΡ	3.51	3.58	3.65
Q	5.34	5.46	5.58
S	5.34	5.46	5.58
b	1.17	1.26	1.35
b2	1.53	1.65	1.77
b4	2.42	2.54	2.66
С	0.51	0.61	0.71
D1	13.08	?	~
D2	0.51	0.93	1.35
E1	12.81	~	~
ØP1	6.60	6.80	7.00

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